

### Description

### **40V N-CHANNEL ENHANCEMENT MODE POWER MOSFET**

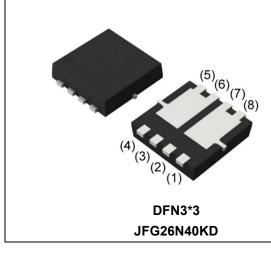
#### Features

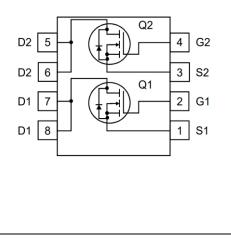
Package

- Device Rating V<sub>DS</sub> = 40V, I<sub>D</sub> = 36A
- R<sub>DS(ON)</sub> =15mΩ (typ.) @ V<sub>GS</sub> = 10V, I<sub>D</sub> = 20A
- R<sub>DS(ON)</sub> =28mΩ (typ.) @ V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 10A
- Proprietary High Density Trench Technology
- RoHS Compliant & Halogen-Free

### Application

- Wireless Charger
- Load Switch





#### Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise specified

Symbol	Parameter		Max.	Units	
V <sub>DS</sub>	Drain-Source Voltage		40	V	
V <sub>GS</sub>	Gate-Source Voltage		± 20	V	
ID	Continuous Drain Current, VGS @ 10V <sup>note1</sup>	Tc = 25℃	36	Α	
		Tc = 100℃	22	А	
Ідм	Pulsed Drain Current note2		144	Α	
PD	Power Dissipation note4	Tc = 25℃	36	W	
	Power Dissipation	T <sub>A</sub> = 25℃	1.2	W	
Eas	Single Pulsed Avalanche Energy note3		24	mJ	
Rejc	Thermal Resistance, Junction to Case note1		3.45	°C/W	
R <sub>0JA</sub>	Junction-to-Ambient (mounted on 1 inch square PCB)		105	°C <b>/W</b>	
TJ, TSTG	Operating and Storage Temperature Range		-55 to +150	°C	

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### Electrical Characteristics Tc=25°C unless otherwise specified

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Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic		•			•
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	40	-	-	V
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V	-	-	1	μA
		V <sub>DS</sub> = 40V, T <sub>C</sub> = 55℃	-	-	10	μA
lgss	Gate-Source Leakage Current	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-100	-	100	nA
On Charac	cteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0	-	2.5	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance note2	V <sub>GS</sub> = 10V, I <sub>D</sub> =20A	-	15	18	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> =10A	-	28	34	mΩ
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> = 5V, I <sub>D</sub> =10A	-	23	-	S
Dynamic (	Characteristics					
Rg	Gate Resistance		-	1.5	-	Ω
Ciss	Input Capacitance	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V,	-	306	-	pF
Coss	Output Capacitance		-	69	-	pF
Crss	Reverse Transfer Capacitance	f = 1.0MHz	-	62	-	pF
Qg	Total Gate Charge	V <sub>DS</sub> =20V, I <sub>D</sub> = 10A,	-	9.05	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	1.12	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge	– V <sub>GS</sub> = 10V	-	3.32	-	nC
Switching	Characteristics		·			
t <sub>d(on)</sub>	Turn-On Delay Time		-	10	-	ns
tr	Turn-On Rise Time	V <sub>DD</sub> = 20V, I <sub>D</sub> = 10A, R <sub>G</sub> = 2Ω, V <sub>GS</sub> = 4.5V	-	32	_	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	26	_	ns
t <sub>f</sub>	Turn-Off Fall Time	-	-	11	-	ns
Drain-Sou	rce Diode Characteristics and Maximum I	Ratings				
ls	Maximum Continuous Drain to Source Diode Forward Current note1,5		-	-	30	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current note2,5		-	-	144	Α
t <sub>rr</sub>	Reverse Recovery Time	T <sub>J</sub> = 25°C, I <sub>S</sub> = 10A,	-	40	-	ns
		V <sub>GS</sub> = 0V				
Qrr	Reverse Recovery Charge	T <sub>J</sub> = 25°C, I <sub>S</sub> = 10A,		20		nC
		di/dt = 150A/µs				
$V_{\text{SD}}$ note2	Drain to Source Diode Forward Voltage	$T_{\rm J} = 25^{\circ}C, I_{\rm S} = 10A,$		0.88	-	v
		V <sub>GS</sub> = 0V	-			

Note :

1. The data tested by surface mounted on one inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed, pulse width  $\leq$  300us, duty cycle  $\leq$  2%.

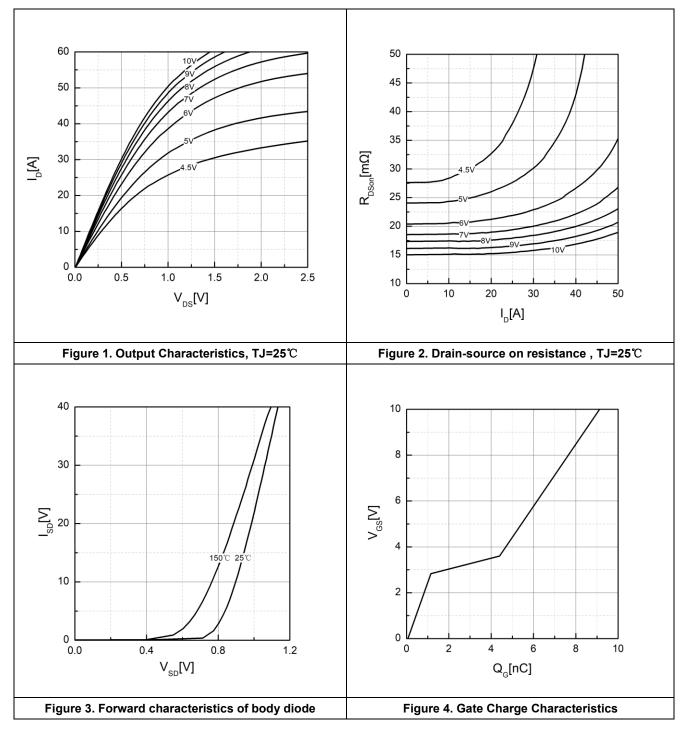
3. The EAS data shows Max. rating. The test condition is  $V_{DD}=40V$ ,  $V_{GS}=10V$ , L=0.1mH,  $I_{AS}=21.9$  A.

4.The power dissipation is limited by 150°C junction temperature.

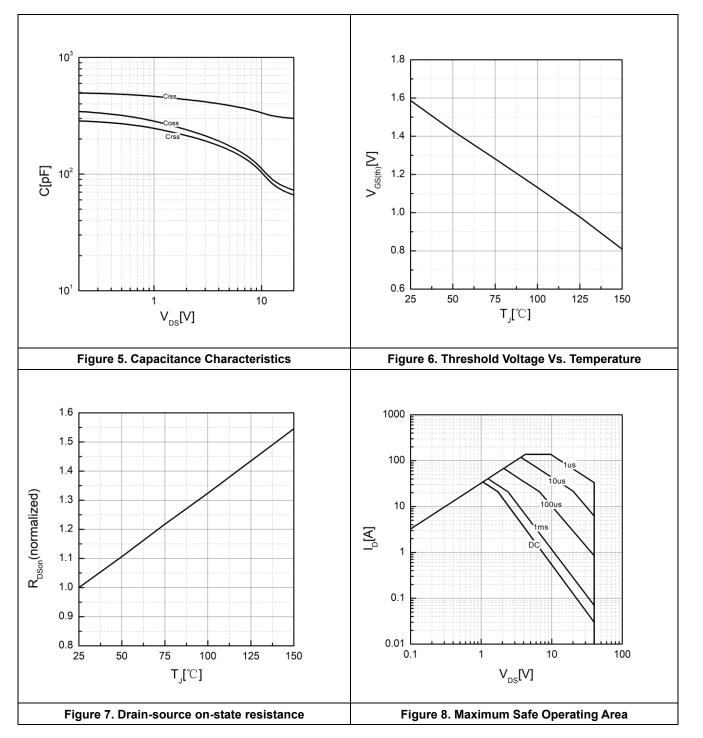
5. The data is theoretically the same as  ${\sf I}_{\sf D}$  and  ${\sf I}_{\sf DM},$  in real applications, should be limited by total power dissipation.



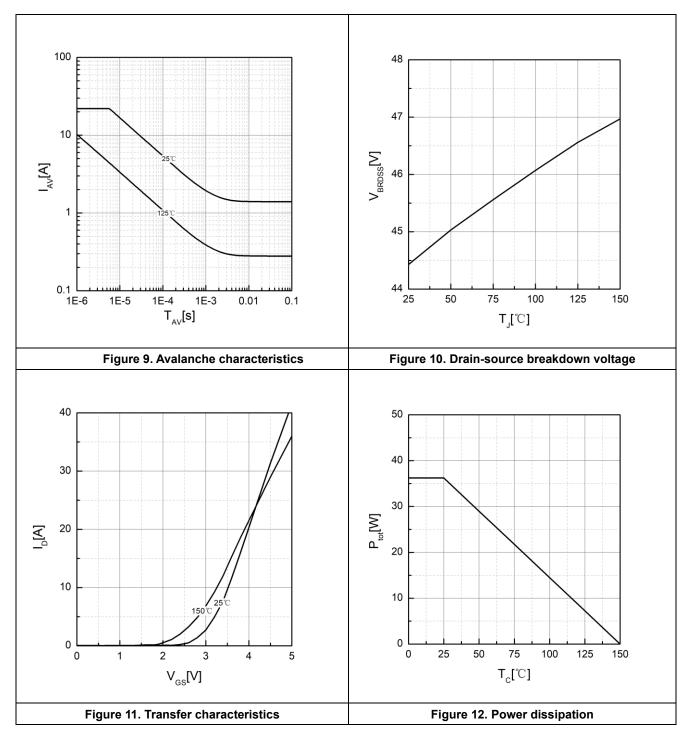
### **Typical Performance Characteristics**



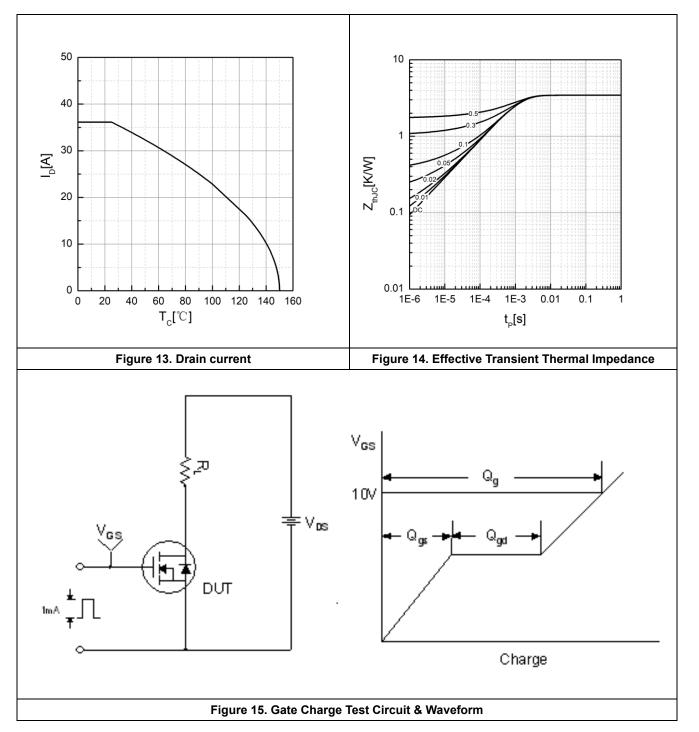




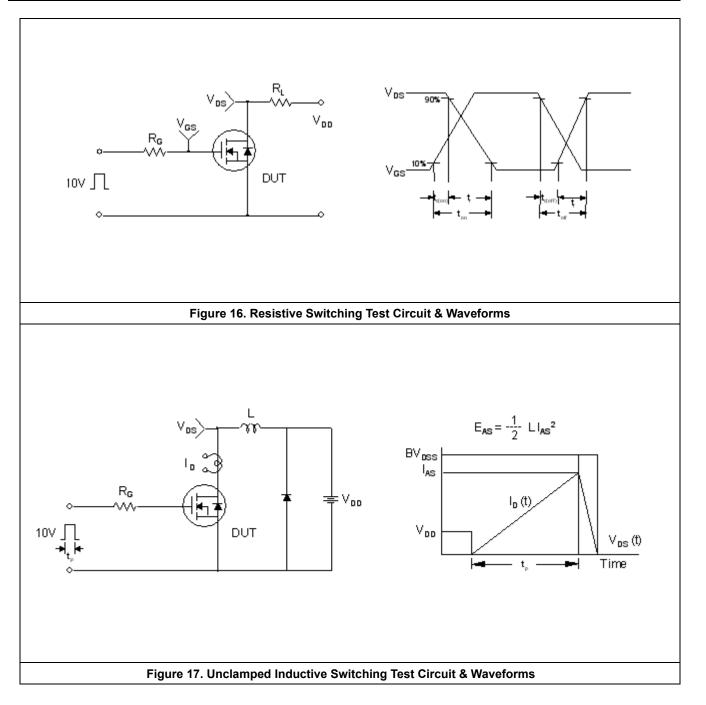




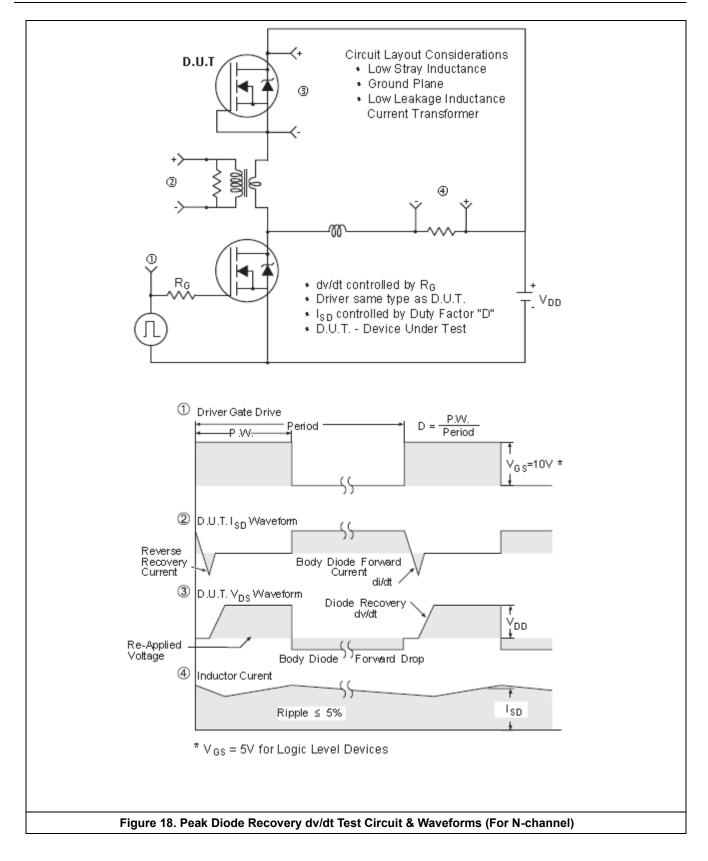








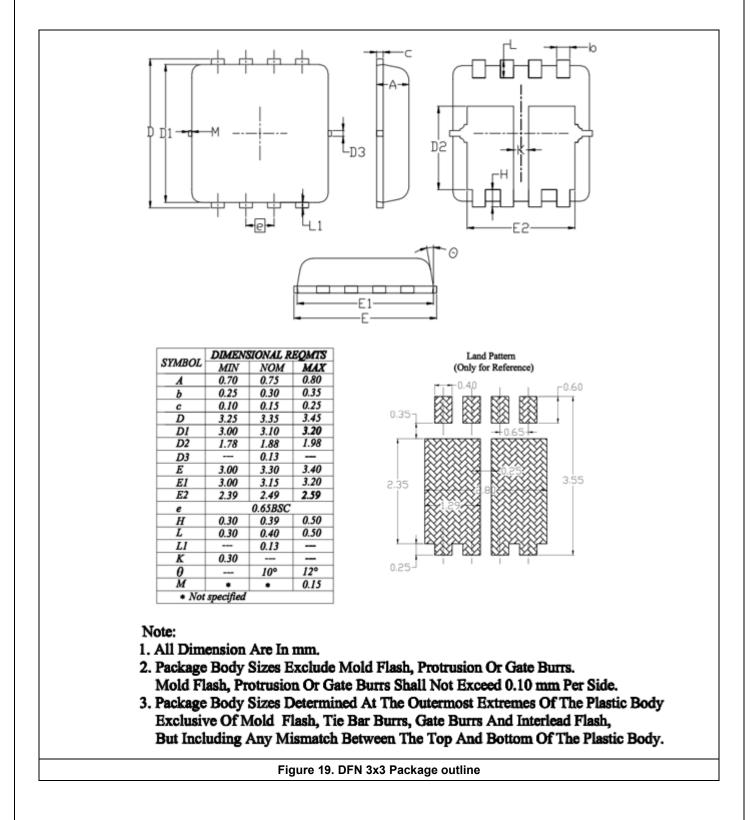




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### Package outline





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